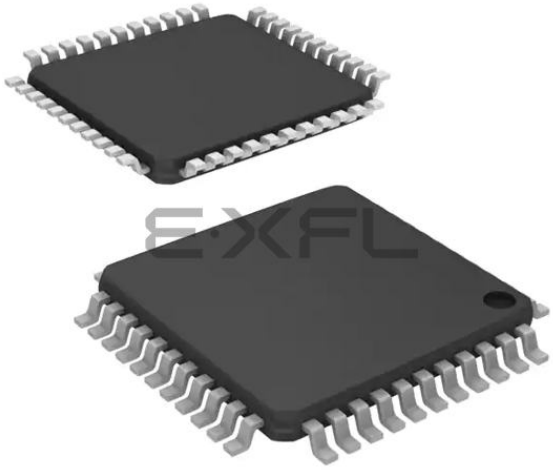
Microchip Technology - DSPIC33EP128GS804T-I/PT Datasheet



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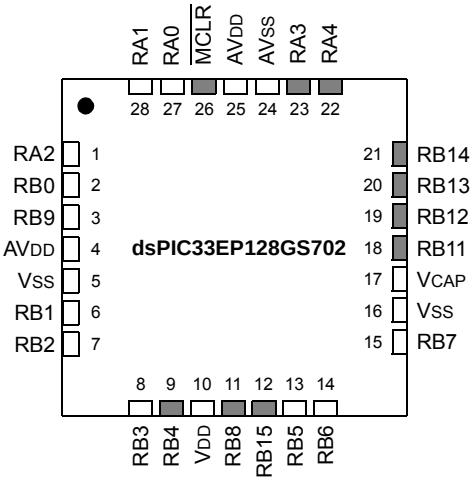
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	70 MIPs
Connectivity	CANbus, I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	33
Program Memory Size	128KB (43K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 17x12b; D/A 1x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep128gs804t-i-pt

Pin Diagrams (Continued)

28-Pin QFN-S, UQFN

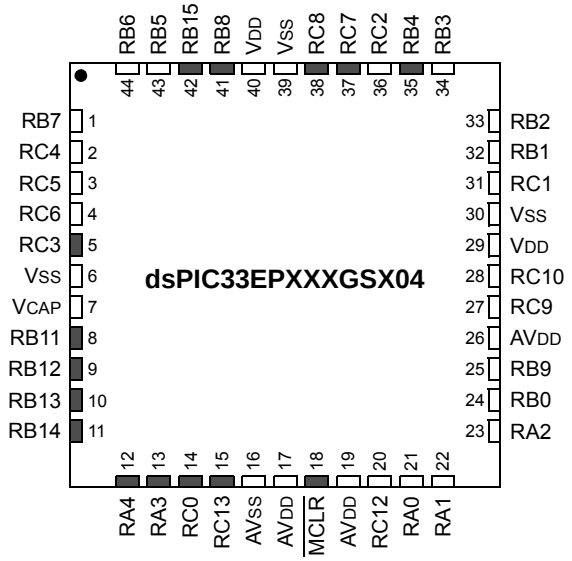


Pin	Pin Function	Pin	Pin Function
1	AN2/CMP1C/CMP2A/PGA1P3/PGA2P2/**RP18**/RA2	15	PGEC1/AN21/SDA1/**RP39**/RB7
2	AN3/CMP1D/CMP2B/PGA2P3/**RP32**/RB0	16	VSS
3	AN4/CMP2C/CMP3A/ISRC4/**RP41**/RB9	17	VCAP
4	AVDD	18	TMS/PWM3H/**RP46**/RB11
5	VSS	19	TCK/PWM3L/**RP44**/RB12
6	OSCI/CLKI/AN6/CMP3C/CMP4A/ISRC2/**RP33**/RB1	20	PWM2H/**RP45**/RB13
7	OSC2/CLKO/AN7/CMP3D/CMP4B/PGA1N2/**RP34**/RB2	21	PWM2L/**RP46**/RB14
8	PGED2/DACOUT1/AN18/INT0/**RP35**/RB3	22	PWM1H/**RP20**/RA4
9	PGEC2/ADTRG31/EXTREF1/**RP36**/RB4	23	PWM1L/**RP19**/RA3
10	VDD	24	AVSS
11	PGED3/SDA2/FLT31/**RP40**/RB8	25	AVDD
12	PGEC3/SCL2/**RP47**/RB15	26	$\overline{\text{MCLR}}$
13	TDO/AN19/PGA2N2/**RP37**/RB5	27	AN0/CMP1A/PGA1P1/**RP16**/RA0
14	PGED1/TDI/AN20/SCL1/**RP38**/RB6	28	AN1/CMP1B/PGA1P2/PGA2P1/**RP17**/RA1

Legend: **Shaded pins** are up to 5 VDC tolerant.
RPn represents remappable peripheral functions. See Table 11-12 and Table 11-13 for the complete list of remappable sources.

Pin Diagrams (Continued)

44-Pin QFN, TQFP

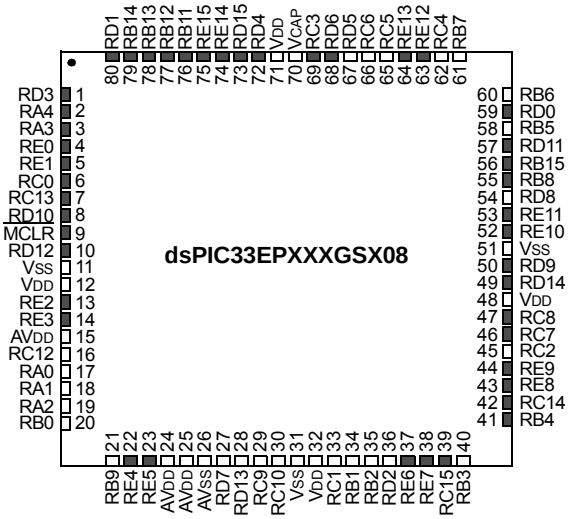


Pin	Pin Function	Pin	Pin Function
1	PGEC1/AN21/SDA1/**RP39**/RB7	23	AN2/CMP1C/CMP2A/PGA1P3/PGA2P2/**RP18**/RA2
2	AN1ALT/**RP52**/RC4	24	AN3/CMP1D/CMP2B/PGA2P3/**RP32**/RB0
3	AN0ALT/**RP53**/RC5	25	AN4/CMP2C/CMP3A/ISRC4/**RP41**/RB9
4	AN17/**RP54**/RC6	26	AVDD
5	**RP51**/RC3	27	AN11/PGA1N3/**RP57**/RC9
6	VSS	28	EXTREF2/AN10/PGA1P4/**RP58**/RC10
7	VCAP	29	VDD
8	TMS/PWM3H/**RP43**/RB11	30	VSS
9	TCK/PWM3L/**RP44**/RB12	31	AN8/CMP4C/PGA2P4/**RP49**/RC1
10	PWM2H/**RP45**/RB13	32	OSCI/CLKI/AN6/CMP3C/CMP4A/ISRC2/**RP33**/RB1
11	PWM2L/**RP46**/RB14	33	OSC2/CLKO/AN7/CMP3D/CMP4B/PGA1N2/**RP34**/RB2
12	PWM1H/**RP20**/RA4	34	PGED2/DACOUT1/AN18/INT0/**RP35**/RB3
13	PWM1L/**RP19**/RA3	35	PGEC2/ADTRG31/**RP36**/RB4
14	FLT12/**RP48**/RC0	36	EXTREF1/AN9/CMP4D/**RP50**/RC2
15	FLT11/**RP61**/RC13	37	ASDA1/**RP55**/RC7
16	AVSS	38	ASCL1/**RP56**/RC8
17	AVDD	39	VSS
18	$\overline{\text{MCLR}}$	40	VDD
19	AVDD	41	PGED3/SDA2/FLT31/**RP40**/RB8
20	AN14/PGA2N3/**RP60**/RC12	42	PGEC3/SCL2/**RP47**/RB15
21	AN0/CMP1A/PGA1P1/**RP16**/RA0	43	TDO/AN19/PGA2N2/**RP37**/RB5
22	AN1/CMP1B/PGA1P2/PGA2P1/**RP17**/RA1	44	PGED1/TDI/AN20/SCL1/**RP38**/RB6

Legend: **Shaded pins** are up to 5 VDC tolerant.
RPn represents remappable peripheral functions. See Table 11-12 and Table 11-13 for the complete list of remappable sources.

Pin Diagrams (Continued)

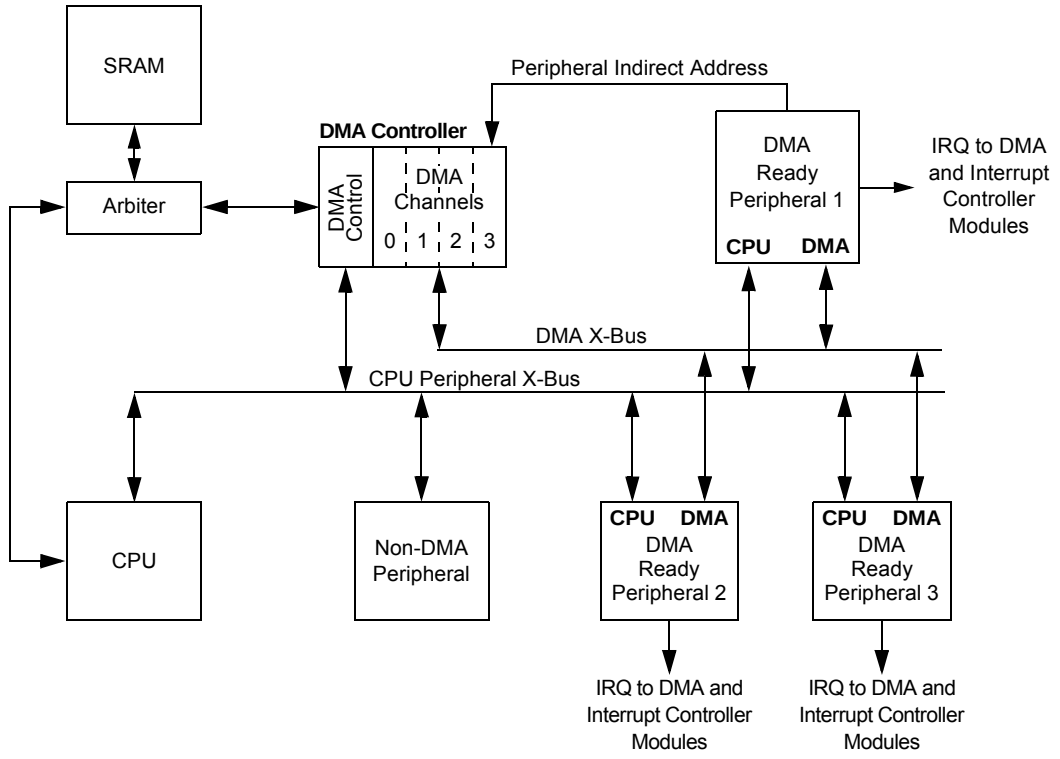
80-Pin TQFP



Pin	Pin Function	Pin	Pin Function
1	PWM4L/**RP67**/RD3	41	PGEC2/ADTRG31/**RP36**/RB4
2	PWM1H/**RP20**/RA4	42	**RP62**/RC14
3	PWM1L/**RP19**/RA3	43	RE8
4	PWM8L/RE0	44	RE9
5	PWM8H/RE1	45	EXTREF1/AN9/CMP4D/**RP50**/RC2
6	FLT12/**RP48**/RC0	46	ASDA1/**RP55**/RC7
7	FLT11/**RP61**/RC13	47	ASCL1/**RP56**/RC8
8	CLC4OUT/FLT10/**RP74**/RD10	48	VDD
9	MCLR	49	CLC3OUT/RD14
10	T5CK/FLT9/**RP76**/RD12	50	SCK3/**RP73**/RD9
11	VSS	51	VSS
12	VDD	52	FLT21/RE10
13	FLT17/RE2	53	FLT22/RE11
14	FLT18/RE3	54	AN5/CMP2D/CMP3B/ISRC3/**RP72**/RD8
15	AVDD	55	PGED3/SDA2/FLT31/**RP40**/RB8
16	AN14/PGA2N3/**RP60**/RC12	56	PGEC3/SCL2/**RP47**/RB15
17	AN0/CMP1A/PGA1P1/**RP16**/RA0	57	INT4/**RP75**/RD11
18	AN1/CMP1B/PGA1P2/PGA2P1/**RP17**/RA1	58	TD0/AN19/PGA2N2/**RP37**/RB5
19	AN2/CMP1C/CMP2A/PGA1P3/PGA2P2/**RP18**/RA2	59	T4CK/**RP64**/RD0
20	AN3/CMP1D/CMP2B/PGA2P3/**RP32**/RB0	60	PGED1/TDI/AN20/SCL1/**RP38**/RB6
21	AN4/CMP2C/CMP3A/ISRC4/**RP41**/RB9	61	PGEC1/AN21/SDA1/**RP39**/RB7
22	RE4	62	AN1ALT/**RP52**/RC4
23	RE5	63	RE12
24	AVDD	64	RE13
25	AVDD	65	AN0ALT/**RP53**/RC5
26	AVSS	66	AN17/**RP54**/RC6
27	AN15/**RP71**/RD7	67	AN12/ISRC1/**RP69**/RD5
28	DACOUT2/AN13/RD13	68	PWM5H/**RP70**/RD6
29	AN11/PGA1N3/**RP57**/RC9	69	PWM5L/**RP51**/RC3
30	EXTREF2/AN10/PGA1P4/**RP58**/RC10	70	VCAP
31	VSS	71	VDD
32	VDD	72	PWM6H/**RP68**/RD4
33	AN8/CMP4C/PGA2P4/**RP49**/RC1	73	PWM6L/RD15
34	OSCI/CLKI/AN6/CMP3C/CMP4A/ISRC2/**RP33**/RB1	74	PWM7L/RE14
35	OSC2/CLKO/AN7/CMP3D/CMP4B/PGA1N2/**RP34**/RB2	75	PWM7H/RE15
36	AN16/**RP66**/RD2	76	TMS/PWM3H/**RP43**/RB11
37	FLT19/RE6	77	TCK/PWM3L/**RP44**/RB12
38	FLT20/RE7	78	PWM2H/**RP45**/RB13
39	ASDA2/**RP63**/RC15	79	PWM2L/**RP46**/RB14
40	PGED2/DACOUT1/AN18/ASCL2/INT0/**RP35**/RB3	80	PWM4H/**RP65**/RD1

Legend: **Shaded pins** are up to 5 VDC tolerant.
RPn represents remappable peripheral functions. See Table 11-12 and Table 11-13 for the complete list of remappable sources.

FIGURE 8-2: DMA CONTROLLER BLOCK DIAGRAM



Note: CPU and DMA address buses are not shown for clarity.

TABLE 9-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION

Oscillator Mode	Oscillator Source	POSCMD<1:0>	FNOSC<2:0>	See Notes
Fast RC Oscillator with Divide-by-n (FRCDIVN)	Internal	xx	111	**1, 2**
Fast RC Oscillator with Divide-by-16	Internal	xx	110	**1**
Low-Power RC Oscillator (LPRC)	Internal	xx	101	**1**
Primary Oscillator (HS) with PLL (HSPLL)	Primary	10	011	
Primary Oscillator (XT) with PLL (XTPLL)	Primary	01	011	
Primary Oscillator (EC) with PLL (ECPLL)	Primary	00	011	**1**
Primary Oscillator (HS)	Primary	10	010	
Primary Oscillator (XT)	Primary	01	010	
Primary Oscillator (EC)	Primary	00	010	**1**
Fast RC Oscillator (FRC) with Divide-by-N and PLL (FRCPLL)	Internal	xx	001	**1**
Fast RC Oscillator (FRC)	Internal	xx	000	**1**

Note 1: OSC2 pin function is determined by the OSCIOFNC Configuration bit.

2: This is the default Oscillator mode for an unprogrammed (erased) device.

9.2 Auxiliary Clock Generation

The auxiliary clock generation is used for peripherals that need to operate at a frequency unrelated to the system clock, such as PWM or ADC.

The primary oscillator and internal FRC oscillator sources can be used with an Auxiliary PLL (APLL) to obtain the auxiliary clock. The Auxiliary PLL has a fixed 16x multiplication factor.

The auxiliary clock has the following configuration restrictions:

- For proper PWM operation, auxiliary clock generation must be configured for 120 MHz (see Parameter OS56 in **Section 30.0 “Electrical Characteristics”**). If a slower frequency is desired, the PWM Input Clock Prescaler (Divider) Select bits (PCLKDIV<2:0>) should be used.
- To achieve 1.04 ns PWM resolution, the auxiliary clock must use the 16x Auxiliary PLL (APLL). All other clock sources will have a minimum PWM resolution of 8 ns.
- If the primary PLL is used as a source for the auxiliary clock, the primary PLL should be configured up to a maximum operation of 30 MIPS or less.

9.3 Reference Clock Generation

The reference clock output logic provides the user with the ability to output a clock signal based on the system clock or the crystal oscillator on a device pin. The user application can specify a wide range of clock scaling prior to outputting the reference clock.

9.4 Oscillator Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page contains the latest updates and additional information.

9.4.1 KEY RESOURCES

- **“Oscillator Module”** (DS70005131) in the *“dsPIC33/PIC24 Family Reference Manual”*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related *“dsPIC33/PIC24 Family Reference Manual”* Sections
- Development Tools

REGISTER 9-6: REFOCON: REFERENCE OSCILLATOR CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ROON	—	ROSSLP	ROSEL	RODIV3(1)	RODIV2(1)	RODIV1(1)	RODIV0(1)
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **ROON:** Reference Oscillator Output Enable bit
1 = Reference oscillator output is enabled on the RPn pin(2)
0 = Reference oscillator output is disabled

bit 14 **Unimplemented:** Read as '0'

bit 13 **ROSSLP:** Reference Oscillator Run in Sleep bit
1 = Reference oscillator output continues to run in Sleep
0 = Reference oscillator output is disabled in Sleep

bit 12 **ROSEL:** Reference Oscillator Source Select bit
1 = Oscillator crystal is used as the reference clock
0 = System clock is used as the reference clock

bit 11-8 **RODIV<3:0>:** Reference Oscillator Divider bits(1)
1111 = Reference clock divided by 32,768
1110 = Reference clock divided by 16,384
1101 = Reference clock divided by 8,192
1100 = Reference clock divided by 4,096
1011 = Reference clock divided by 2,048
1010 = Reference clock divided by 1,024
1001 = Reference clock divided by 512
1000 = Reference clock divided by 256
0111 = Reference clock divided by 128
0110 = Reference clock divided by 64
0101 = Reference clock divided by 32
0100 = Reference clock divided by 16
0011 = Reference clock divided by 8
0010 = Reference clock divided by 4
0001 = Reference clock divided by 2
0000 = Reference clock

bit 7-0 **Unimplemented:** Read as '0'

Note 1: The reference oscillator output must be disabled (ROON = 0) before writing to these bits.
2: This pin is remappable. See **Section 11.6 "Peripheral Pin Select (PPS)"** for more information.

REGISTER 9-7: LFSR: LINEAR FEEDBACK SHIFT REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	LFSR<14:8>						
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
LFSR<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-0 **LFSR<14:0>:** Pseudorandom Data bits

REGISTER 11-7: CNPDx: INPUT CHANGE NOTIFICATION PULL-DOWN ENABLE x REGISTER(1)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CNPDx<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CNPDx<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **CNPDx<15:0>:** Input Change Notification Pull-Down Enable x bits
1 = Enables pull-down on PORTx pin
0 = Disables pull-down on PORTx pin

Note 1: See Table 11-1, Table 11-2, Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

REGISTER 11-8: ANSELx: ANALOG SELECT CONTROL x REGISTER(1)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANSx<15:8>							
bit 15							bit 8

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANSx<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **ANSx<15:0>:** Analog PORTx Enable bits
1 = Enables analog PORTx pin
0 = Disables digital PORTx pin

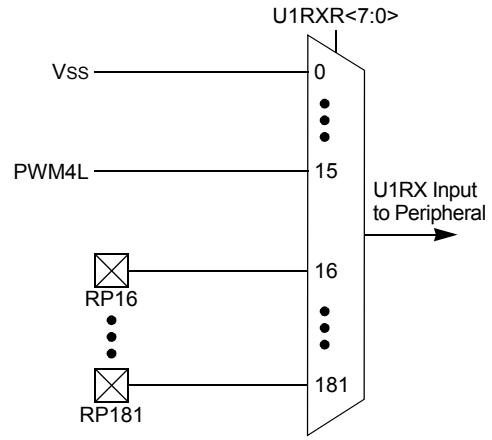
Note 1: See Table 11-1, Table 11-2, Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

11.6.4 INPUT MAPPING

The inputs of the Peripheral Pin Select options are mapped on the basis of the peripheral. That is, a control register associated with a peripheral dictates the pin it will be mapped to. The RPINRx registers are used to configure peripheral input mapping (see Register 11-9 through Register 11-32). Each register contains sets of 8-bit fields, with each set associated with one of the remappable peripherals. Programming a given peripheral's bit field with an appropriate 8-bit index value maps the RPn pin with the corresponding value, or internal signal, to that peripheral. See Table 11-11 for a list of available inputs.

For example, Figure 11-2 illustrates remappable pin selection for the U1RX input.

FIGURE 11-2: REMAPPABLE INPUT FOR U1RX



Note: For input only, Peripheral Pin Select functionality does not have priority over TRISx settings. Therefore, when configuring an RPn pin for input, the corresponding bit in the TRISx register must also be configured for input (set to '1').

11.6.4.1 Virtual Connections

The dsPIC33EPXXXGS70X/80X devices support six virtual RPn pins (RP176-RP181), which are identical in functionality to all other RPn pins, with the exception of pinouts. These six pins are internal to the devices and are not connected to a physical device pin.

These pins provide a simple way for inter-peripheral connection without utilizing a physical pin. For example, the output of the analog comparator can be connected to RP176 and the PWM Fault input can be configured for RP176 as well. This configuration allows the analog comparator to trigger PWM Faults without the use of an actual physical pin on the device.

TABLE 11-11: REMAPPABLE SOURCES

Remap Index	Output Function
0	Vss
1	CMP1
2	CMP2
3	CMP3
4	CMP4
5	PWM4H
6	PTGO30
7	PTGO31
8-11	Reserved
12	REFO
13	SYNCO1
14	SYNCO2
15	PWM4L
16-20	RP16-RP20
21-31	Reserved
32-41	RP32-RP41
42	Reserved
43-58	RP43-RP58
59	Reserved
60-76	RP60-RP76
77-175	Reserved
176-181	RP176-RP181

11.7 I/O Helpful Tips

1. In some cases, certain pins, as defined in Table 30-11 under “Injection Current”, have internal protection diodes to VDD and VSS. The term, “Injection Current”, is also referred to as “Clamp Current”. On designated pins, with sufficient external current-limiting precautions by the user, I/O pin input voltages are allowed to be greater or less than the data sheet absolute maximum ratings, with respect to the VSS and VDD supplies. Note that when the user application forward biases either of the high or low-side internal input clamp diodes, that the resulting current being injected into the device, that is clamped internally by the VDD and VSS power rails, may affect the ADC accuracy by four to six counts.
2. I/O pins that are shared with any analog input pin (i.e., ANx) are always analog pins, by default, after any Reset. Consequently, configuring a pin as an analog input pin automatically disables the digital input pin buffer and any attempt to read the digital input level by reading PORTx or LATx will always return a ‘0’, regardless of the digital logic level on the pin. To use a pin as a digital I/O pin on a shared ANx pin, the user application needs to configure the Analog Pin Configuration registers (i.e., ANSELx) in the I/O ports module by setting the appropriate bit that corresponds to that I/O port pin to a ‘0’.

Note:	Although it is not possible to use a digital input pin when its analog function is enabled, it is possible to use the digital I/O output function, TRISx = 0x0, while the analog function is also enabled. However, this is not recommended, particularly if the analog input is connected to an external analog voltage source, which would create signal contention between the analog signal and the output pin driver.

3. Most I/O pins have multiple functions. Referring to the device pin diagrams in this data sheet, the priorities of the functions allocated to any pins are indicated by reading the pin name from left-to-right. The left most function name takes precedence over any function to its right in the naming convention. For example: AN16/T2CK/T7CK/RC1; this indicates that AN16 is the highest priority in this example and will supersede all other functions to its right in the list. Those other functions to its right, even if enabled, would not work as long as any other function to its left was enabled. This rule applies to all of the functions listed for a given pin.
4. Each pin has an internal weak pull-up resistor and pull-down resistor that can be configured using the CNPUx and CNPDx registers, respectively. These resistors eliminate the need for external resistors in certain applications. The internal pull-up is up to ~(VDD – 0.8), not VDD. This value is still above the minimum VIH of CMOS and TTL devices.
5. When driving LEDs directly, the I/O pin can source or sink more current than what is specified in the VOH/IOH and VOL/IOL DC characteristics specification. The respective IOH and IOL current rating only applies to maintaining the corresponding output at or above the VOH, and at or below the VOL levels. However, for LEDs, unlike digital inputs of an externally connected device, they are not governed by the same minimum VIH/VIL levels. An I/O pin output can safely sink or source any current less than that listed in the Absolute Maximum Ratings in **Section 30.0 “Electrical Characteristics”**of this data sheet. For example:

   VOH = 2.4v @ IOH = -8 mA and VDD = 3.3V

   The maximum output current sourced by any 8 mA I/O pin = 12 mA.

   LED source current < 12 mA is technically permitted. Refer to the VOH/IOH graphs in **Section 31.0 “DC and AC Device Characteristics Graphs”** for additional information.

REGISTER 11-21: RPINR21: PERIPHERAL PIN SELECT INPUT REGISTER 21

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SS1R7	SS1R6	SS1R5	SS1R4	SS1R3	SS1R2	SS1R1	SS1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as ‘0’

bit 7-0 **SS1R<7:0>:** Assign SPI1 Slave Select ($\overline{SS1}$) to the Corresponding RPn Pin bits
See Table 11-11 which contains a list of remappable inputs for the index value.

REGISTER 11-22: RPINR22: PERIPHERAL PIN SELECT INPUT REGISTER 22

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SCK2INR7	SCK2INR6	SCK2INR5	SCK2INR4	SCK2INR3	SCK2INR2	SCK2INR1	SCK2INR0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SDI2R7	SDI2R6	SDI2R5	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-8 **SCK2INR<7:0>:** Assign SPI2 Clock Input (SCK2) to the Corresponding RPn Pin bits
See Table 11-11 which contains a list of remappable inputs for the index value.

bit 7-0 **SDI2R<7:0>:** Assign SPI2 Data Input (SDI2) to the Corresponding RPn Pin bits
See Table 11-11 which contains a list of remappable inputs for the index value.

17.0 PERIPHERAL TRIGGER GENERATOR (PTG) MODULE

Note 1: This data sheet summarizes the features of the dsPIC33EPXXXGS70X/80X family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Peripheral Trigger Generator (PTG)"** (DS70669) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

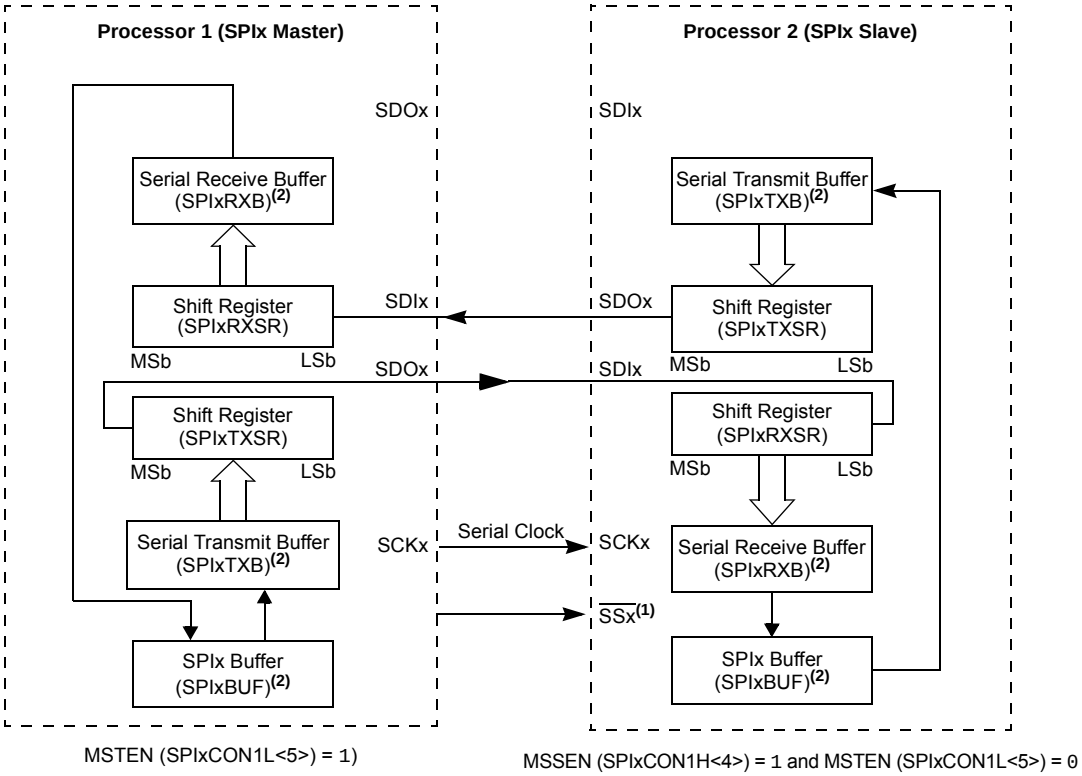
17.1 Module Introduction

The Peripheral Trigger Generator (PTG) provides a means to schedule complex, high-speed peripheral operations that would be difficult to achieve using software. The PTG module uses 8-bit commands, called "Steps", that the user writes to the PTG Queue register (PTGQUE0-PTQUE15) which performs operations, such as wait for input signal, generate output trigger and wait for timer.

The PTG module has the following major features:

- Multiple Clock Sources
- Two 16-Bit General Purpose Timers
- Two 16-Bit General Limit Counters
- Configurable for Rising or Falling Edge Triggering
- Generates Processor Interrupts to include:
  - Four configurable processor interrupts
  - Interrupt on a Step event in Single-Step mode
  - Interrupt on a PTG Watchdog Timer time-out
- Able to Receive Trigger Signals from these Peripherals:
  - ADC
  - PWM
  - Output Compare
  - Input Capture
  - Comparator
  - INT2
- Able to Trigger or Synchronize to these Peripherals:
  - Watchdog Timer
  - Output Compare
  - Input Capture
  - ADC
  - PWM
  - Comparator

FIGURE 18-3: SPIx MASTER/SLAVE CONNECTION (STANDARD MODE)



Note 1: Using the $\overline{SSx}$ pin in Slave mode of operation is optional.

2: User must write transmit data to read the received data from SPIxBUF. The SPIxTXB and SPIxRXB registers are memory-mapped to SPIxBUF.

REGISTER 22-26: ADTRIGxL: ADC CHANNEL TRIGGER x SELECTION REGISTER LOW (x = 0 to 5)

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	TRGSRC(4x+1)<4:0>				
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	TRGSRC(4x)<4:0>				
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **TRGSRC(4x+1)<4:0>:** Trigger Source Selection for Corresponding Analog Inputs bits

11111 = ADTRG31
11110 = PTG Trigger Output 12
11101 = PWM Generator 6 current-limit trigger
11100 = PWM Generator 5 current-limit trigger
11011 = PWM Generator 4 current-limit trigger
11010 = PWM Generator 3 current-limit trigger
11001 = PWM Generator 2 current-limit trigger
11000 = PWM Generator 1 current-limit trigger
10111 = Output Compare 2 trigger
10110 = Output Compare 1 trigger
10101 = CLC2 output
10100 = PWM Generator 6 secondary trigger
10011 = PWM Generator 5 secondary trigger
10010 = PWM Generator 4 secondary trigger
10001 = PWM Generator 3 secondary trigger
10000 = PWM Generator 2 secondary trigger
01111 = PWM Generator 1 secondary trigger
01110 = PWM secondary Special Event Trigger
01101 = Timer2 period match
01100 = Timer1 period match
01011 = CLC1 output
01010 = PWM Generator 6 primary trigger
01001 = PWM Generator 5 primary trigger
01000 = PWM Generator 4 primary trigger
00111 = PWM Generator 3 primary trigger
00110 = PWM Generator 2 primary trigger
00101 = PWM Generator 1 primary trigger
00100 = PWM Special Event Trigger
00011 = Reserved
00010 = Level software trigger
00001 = Common software trigger
00000 = No trigger is enabled

bit 7-5 **Unimplemented:** Read as '0'

TABLE 28-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Base Instr #	Assembly Mnemonic	Assembly Syntax		Description	# of Words	# of Cycles(1)	Status Flags Affected
74	SL	SL	f	f = Left Shift f	1	1	C,N,OV,Z
		SL	f,WREG	WREG = Left Shift f	1	1	C,N,OV,Z
		SL	Ws,Wd	Wd = Left Shift Ws	1	1	C,N,OV,Z
		SL	Wb,Wns,Wnd	Wnd = Left Shift Wb by Wns	1	1	N,Z
		SL	Wb,#lit5,Wnd	Wnd = Left Shift Wb by lit5	1	1	N,Z
75	SUB	SUB	Acc	Subtract Accumulators	1	1	OA,OB,OAB, SA,SB,SAB
		SUB	f	f = f – WREG	1	1	C,DC,N,OV,Z
		SUB	f,WREG	WREG = f – WREG	1	1	C,DC,N,OV,Z
		SUB	#lit10,Wn	Wn = Wn – lit10	1	1	C,DC,N,OV,Z
		SUB	Wb,Ws,Wd	Wd = Wb – Ws	1	1	C,DC,N,OV,Z
		SUB	Wb,#lit5,Wd	Wd = Wb – lit5	1	1	C,DC,N,OV,Z
76	SUBB	SUBB	f	f = f – WREG – ($\overline{C}$)	1	1	C,DC,N,OV,Z
		SUBB	f,WREG	WREG = f – WREG – ($\overline{C}$)	1	1	C,DC,N,OV,Z
		SUBB	#lit10,Wn	Wn = Wn – lit10 – ($\overline{C}$)	1	1	C,DC,N,OV,Z
		SUBB	Wb,Ws,Wd	Wd = Wb – Ws – ($\overline{C}$)	1	1	C,DC,N,OV,Z
		SUBB	Wb,#lit5,Wd	Wd = Wb – lit5 – ($\overline{C}$)	1	1	C,DC,N,OV,Z
77	SUBR	SUBR	f	f = WREG – f	1	1	C,DC,N,OV,Z
		SUBR	f,WREG	WREG = WREG – f	1	1	C,DC,N,OV,Z
		SUBR	Wb,Ws,Wd	Wd = Ws – Wb	1	1	C,DC,N,OV,Z
		SUBR	Wb,#lit5,Wd	Wd = lit5 – Wb	1	1	C,DC,N,OV,Z
78	SUBBR	SUBBR	f	f = WREG – f – ($\overline{C}$)	1	1	C,DC,N,OV,Z
		SUBBR	f,WREG	WREG = WREG – f – ($\overline{C}$)	1	1	C,DC,N,OV,Z
		SUBBR	Wb,Ws,Wd	Wd = Ws – Wb – ($\overline{C}$)	1	1	C,DC,N,OV,Z
		SUBBR	Wb,#lit5,Wd	Wd = lit5 – Wb – ($\overline{C}$)	1	1	C,DC,N,OV,Z
79	SWAP	SWAP.b	Wn	Wn = nibble swap Wn	1	1	None
		SWAP	Wn	Wn = byte swap Wn	1	1	None
80	TBLRDH	TBLRDH	Ws,Wd	Read Prog<23:16> to Wd<7:0>	1	5	None
81	TBLRDL	TBLRDL	Ws,Wd	Read Prog<15:0> to Wd	1	5	None
82	TBLWTH	TBLWTH	Ws,Wd	Write Ws<7:0> to Prog<23:16>	1	2	None
83	TBLWTL	TBLWTL	Ws,Wd	Write Ws to Prog<15:0>	1	2	None
84	ULNK	ULNK		Unlink Frame Pointer	1	1	SFA
85	XOR	XOR	f	f = f .XOR. WREG	1	1	N,Z
		XOR	f,WREG	WREG = f .XOR. WREG	1	1	N,Z
		XOR	#lit10,Wn	Wd = lit10 .XOR. Wd	1	1	N,Z
		XOR	Wb,Ws,Wd	Wd = Wb .XOR. Ws	1	1	N,Z
		XOR	Wb,#lit5,Wd	Wd = Wb .XOR. lit5	1	1	N,Z
86	ZE	ZE	Ws,Wnd	Wnd = Zero-extend Ws	1	1	C,Z,N

Note 1: Read and Read-Modify-Write (e.g., bit operations and logical operations) on non-CPU SFRs incur an additional instruction cycle.

TABLE 30-18: PLL CLOCK TIMING SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min.**	**Typ.(1)**	**Max.**	**Units**	**Conditions**
OS50	FPLLI	PLL Voltage Controlled Oscillator (VCO) Input Frequency Range	0.8	—	8.0	MHz	ECPLL, XTPLL modes
OS51	FVCO	On-Chip VCO System Frequency	120	—	340	MHz	
OS52	TLOCK	PLL Start-up Time (Lock Time)	0.9	1.5	3.1	ms	
OS53	DCLK	CLKO Stability (Jitter)(2)	-3	0.5	3	%	

Note 1: Data in "Typ." column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: This jitter specification is based on clock cycle-by-clock cycle measurements. To get the effective jitter for individual time bases, or communication clocks used by the application, use the following formula:

$$\text{Effective Jitter} = \frac{DCLK}{\sqrt{\frac{FOSC}{\text{Time Base or Communication Clock}}}}$$

For example, if FOSC = 120 MHz and the SPIx bit rate = 10 MHz, the effective jitter is as follows:

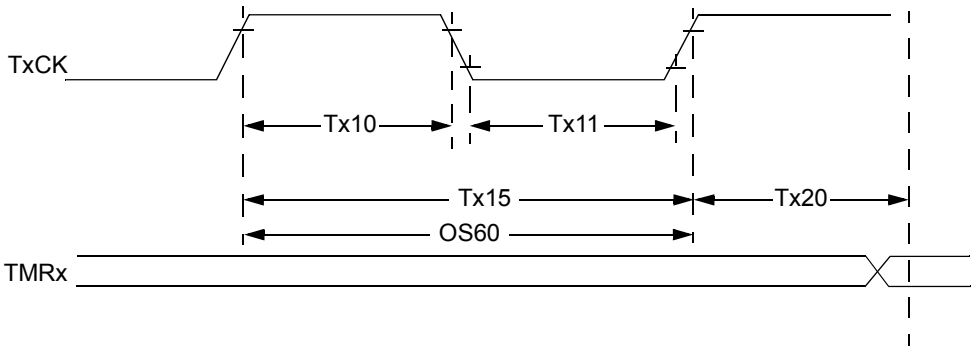
$$\text{Effective Jitter} = \frac{DCLK}{\sqrt{\frac{120}{10}}} = \frac{DCLK}{\sqrt{12}} = \frac{DCLK}{3.464}$$

TABLE 30-19: AUXILIARY PLL CLOCK TIMING SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
OS56	FHPOUT	On-Chip 16x PLL CCO Frequency	112	118	120	MHz	
OS57	FHPIN	On-Chip 16x PLL Phase Detector Input Frequency	7.0	7.37	7.5	MHz	
OS58	TSU	Frequency Generator Lock Time	—	—	10	µs	

Note 1: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested in manufacturing.

FIGURE 30-5: TIMER1-TIMER5 EXTERNAL CLOCK TIMING CHARACTERISTICS



Note: Refer to Figure 30-1 for load conditions.

TABLE 30-24: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS(1)

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(2)**		**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**
TA10	TTXH	T1CK High Time	Synchronous mode	Greater of: 20 or (TCY + 20)/N	—	—	ns	Must also meet Parameter TA15, N = Prescale Value (1, 8, 64, 256)
			Asynchronous mode	35	—	—	ns	
TA11	TTXL	T1CK Low Time	Synchronous mode	Greater of: 20 or (TCY + 20)/N	—	—	ns	Must also meet Parameter TA15, N = Prescale Value (1, 8, 64, 256)
			Asynchronous mode	10	—	—	ns	
TA15	TTXP	T1CK Input Period	Synchronous mode	Greater of: 40 or (2 TCY + 40)/N	—	—	ns	N = Prescale Value (1, 8, 64, 256)
OS60	Ft1	T1CK Oscillator Input Frequency Range (oscillator enabled by setting bit, TCS (T1CON<1>))		DC	—	50	kHz	
TA20	TCKEXTMRL	Delay from External T1CK Clock Edge to Timer Increment		0.75 TCY + 40	—	1.75 TCY + 40	ns	

Note 1: Timer1 is a Type A timer.

2: These parameters are characterized but not tested in manufacturing.

TABLE 30-53: ANALOG-TO-DIGITAL CONVERSION TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)[2] Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristics**	**Min.**	**Typ.[1]**	**Max.**	**Units**	**Conditions**
Clock Parameters							
AD50	TAD	ADC Clock Period	14.28	—	—	ns	
Throughput Rate							
AD51	FTP	SH0-SH3	—	—	3.25	Msps	70 MHz ADC clock, 12 bits, no pending conversion at time of trigger
		SH4	—	—	3.25	Msps	

Note 1: These parameters are characterized but not tested in manufacturing.

2: The ADC module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is ensured, but not characterized.

TABLE 30-54: HIGH-SPEED ANALOG COMPARATOR MODULE SPECIFICATIONS

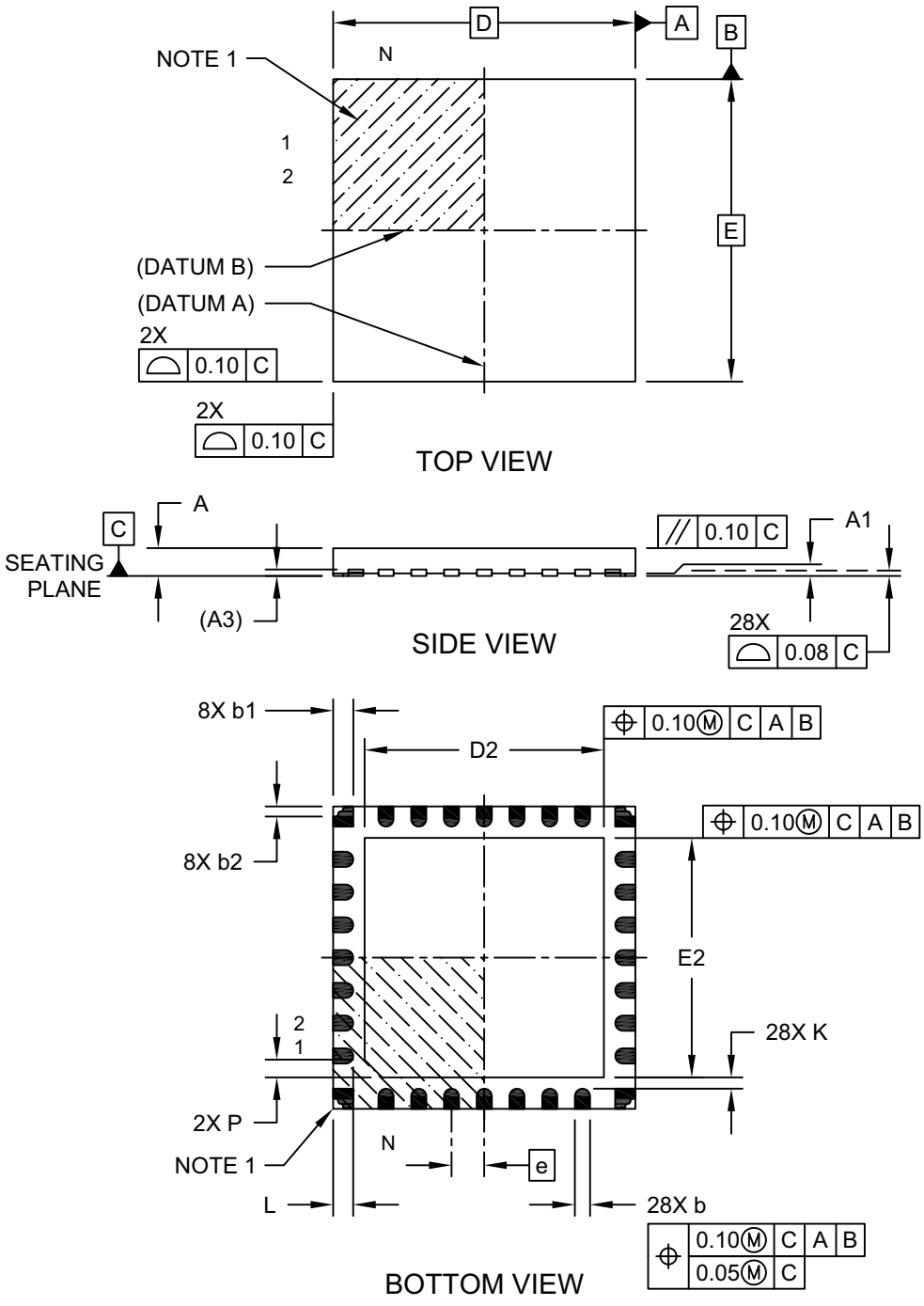
AC/DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)[2] Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Comments**
CM10	VIOFF	Input Offset Voltage	-35	±5	35	mV	
CM11	VICM	Input Common-Mode Voltage Range[1]	0	—	AVDD	V	
CM13	CMRR	Common-Mode Rejection Ratio	60	—	—	dB	
CM14	TRESP	Large Signal Response	—	15	—	ns	V+ input step of 100 mV while V- input is held at AVDD/2. Delay measured from analog input pin to PWMx output pin.
CM15	VHYST	Input Hysteresis	5	10	20	mV	Depends on HYSSEL<1:0>
CM16	TON	Comparator Enabled to Valid Output	—	—	1	µs	

Note 1: These parameters are for design guidance only and are not tested in manufacturing.

2: The comparator module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is tested, but not characterized.

28-Lead Ultra Thin Plastic Quad Flat, No Lead Package (2N) - 6x6x0.55 mm Body [UQFN] With 4.65x4.65 mm Exposed Pad and Corner Anchors

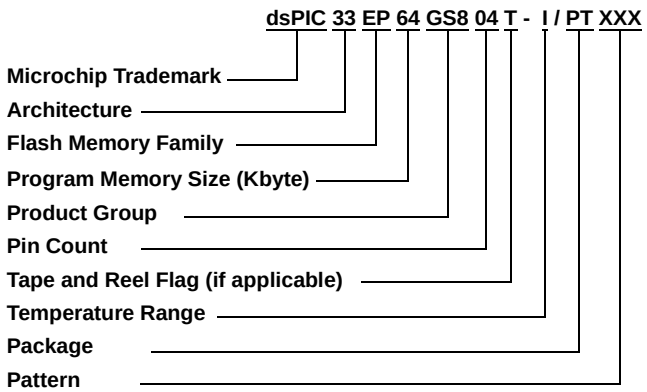
Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-385B Sheet 1 of 2

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.



Architecture:	33	=	16-Bit Digital Signal Controller
Flash Memory Family:	EP	=	Enhanced Performance
Product Group:	GS	=	SMPS Family
Pin Count:	02	=	28-pin
	04	=	44-pin
	05	=	48-pin
	06	=	64-pin
	08	=	80-pin
Temperature Range:	I	=	-40°C to +85°C (Industrial)
	E	=	-40°C to +125°C (Extended)
Package:	ML	=	Plastic Quad, No Lead Package – (44-pin) 8x8 mm body (QFN)
	MM	=	Plastic Quad, No Lead Package – (28-pin) 6x6 mm body (QFN-S)
	2N	=	Plastic Quad Flat, No Lead Package – (28-pin) 6x6 mm body (UQFN)
	PT	=	Plastic Thin Quad Flatpack – (44-pin) 10x10 mm body (TQFP)
	PT	=	Plastic Thin Quad Flatpack – (48-pin) 7x7 mm body (TQFP)
	PT	=	Plastic Thin Quad Flatpack – (64-pin) 10x10 mm body (TQFP)
	PT	=	Plastic Thin Quad Flatpack – (80-pin) 12x12 mm body (TQFP)
	SO	=	Plastic Small Outline, Wide – (28-pin) 7.50 mm body (SOIC)

Examples:

dsPIC33EP64GS804-I/PT:
dsPIC33, Enhanced Performance, 64-Kbyte Program Memory, SMPS, 44-Pin, Industrial Temperature, TQFP Package.